

Product/Process Change (PCN) Notification

PCN Number: CO-23801	Contact: Elizabeth La Greca
Date Issued: June 21 st , 2019	Title: Director, Sales Operations
PCN Effective Date: September 20th, 2019	Phone: 858-795-0106
Product(s) Affected: PE42423	Email: pcn@psemi.com
Sample Availability: Available	
Change Control Board Approval #: CO-23801	
Change Category:	
Wafer Fabrication Process	Shipping/Labeling
Design/Mask Change	Equipment
Singulation Process	Material
Assembly Process	Product Specification
Electrical Test – Location addition	Product End of Life
Manufacturing Site – Assembly site change	🖾 Other - Ordering Code

Purpose of Change:

To enable MagnaChip and Lapis as dual source wafer fabrication sites.

Description of Change:

MagnaChip closed their 150 mm wafer CMOS fab in South Korea at the end of 2015. To ensure there is no disruption to supply, we have been working to transfer products from MagnaChip fab to Lapis fab in Japan. Magnachip and Lapis are qualified Peregrine fabs.

Lapis PE42423 material has been qualified with no change to form, fit, function or reliability.

Beginning September 20th, 2019, PE42423 shipped to customers will be supplied from either MagnaChip or Lapis wafers.

Ordering codes:

(Original) MagnaChip part number: PE42423MLBA-Z, EK42423-02 (New) Lapis part number: PE42423B-Z, EK42423-03

For more information, please contact PCN@psemi.com.



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Customer Acknowledgement of Receipt*:

Change Denied	Name:	
(Include explanation in comments section below)	Title:	
Change Approved	Company:	
	Date:	
	Signature:	
Customer Comments:		